

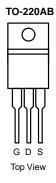
P-Channel 40-V (D-S) MOSFET

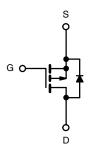
PRODUCT SUMMARY						
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
- 40	0.0041 at V _{GS} = - 10 V	- 110	185 nC			

FEATURES

• TrenchFET® Power MOSFET







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	S T _A = 25 °C, unle	ss otherwise not	ed		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 40	V		
Gate-Source Voltage	V _{GS}	± 20			
	T _C = 25 °C		- 110 ^a		
Continuous Drain Current /T = 175 °C\	T _C = 70 °C		- 110 ^a		
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C	I _D	39 ^{b, c}		
	T _A = 70 °C		33 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	240	_ ^	
Continuous Course Proin Diade Current	T _C = 25 °C	I.	110		
Continuous Source-Drain Diode Current	T _A = 25 °C	l _S —	10 ^{b, c}		
Avalanche Current	L = 0.1 mH	I _{AS}	75		
Single-Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	281	mJ	
	T _C = 25 °C		375		
Maximum Daylar Dissipation	T _C = 70 °C	D_	262	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	15 ^{b, c}	VV	
	T _A = 70 °C		10.5 ^{b, c}	7	
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 175	°C		
Soldering Recommendations (Peak Temperature		260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	8	10	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	0.33	0.4	C/VV	

Notes:

- a. Package limited.
 b. Surface Mounted on 1" x 1" FR4 board.
 c. t = 10 s.
 d. Maximum under Steady State conditions is 40 °C/W.



SPECIFICATIONS $T_J = 25 ^{\circ}\text{C}$, to Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	,			, ,.		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, I}_{D} = -250 \mu\text{A}$	- 40			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A		- 40		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		- 5.5		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 2	- 3	- 4	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	1	V _{DS} = - 40 V, V _{GS} = 0 V			- 1	μА
	IDSS	V _{DS} = - 40 V, V _{GS} = 0 V, T _J = 55 °C	- 10		- 10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = -10 \text{ V}$	- 120			Α
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = - 10 V, I _D = - 20 A		0.0041		Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 20 A		75		S
Dynamic ^b						•
Input Capacitance	C _{iss}			11300		pF
Output Capacitance	C _{oss}	V _{DS} = - 25 V, V _{GS} = 0 V, f = 1 MHz		1510		
Reverse Transfer Capacitance	C _{rss}			1000		
Total Gate Charge	Q_g			185	280	nC
Gate-Source Charge	Q _{gs}	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -110 \text{ A}$		48		
Gate-Drain Charge	Q_{gd}			42		
Gate Resistance	R_g	f = 1 MHz		4.0		Ω
Turn-On Delay Time	t _{d(on)}			25	40	
Rise Time	t _r	$V_{DD} = -20 \text{ V}, R_L = 0.18 \Omega$		290	440	200
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 110 A, V_{GEN} = - 10 V, R_g = 1 Ω		110	165	ns -
Fall Time	t _f			35	55	
Drain-Source Body Diode Characteristic	S					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 110	Α
Pulse Diode Forward Current ^a	I _{SM}				- 240	^
Body Diode Voltage	V_{SD}	I _S = - 20 A		- 0.8	- 1.5	V
Body Diode Reverse Recovery Time	t _{rr}			70	105	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 20 A, di/dt = 100 A/μs, T _J = 25 °C		130	200	nC
Reverse Recovery Fall Time	t _a	- 1 - 20 π, and - 100 πμο, 1 - 20 0		37		ns
Reverse Recovery Rise Time	t _b			33		1115

Notes:

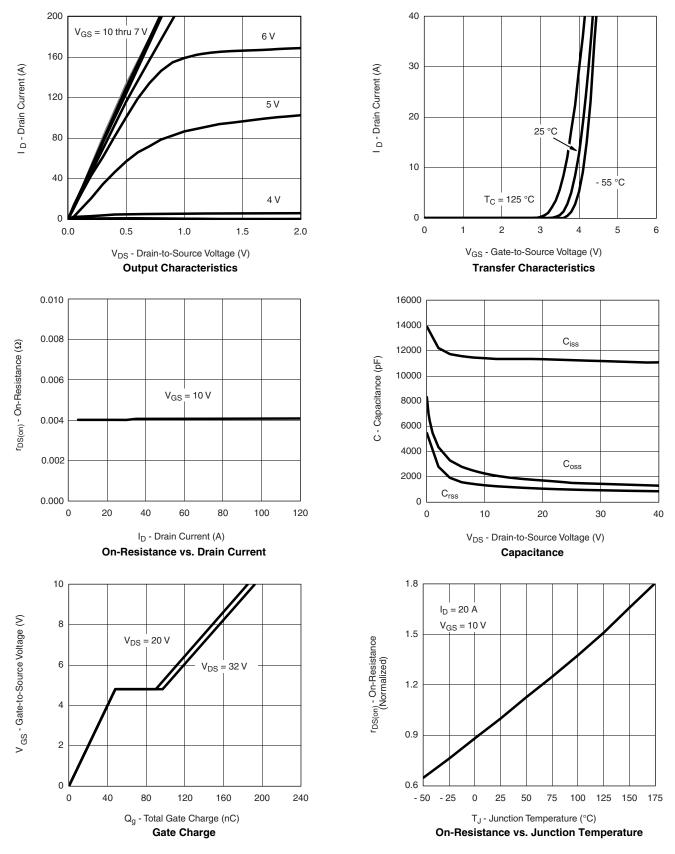
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

b. Guaranteed by design, not subject to production testing.

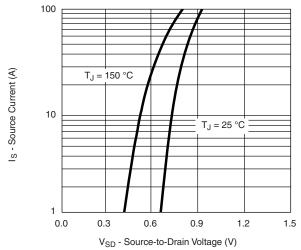


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

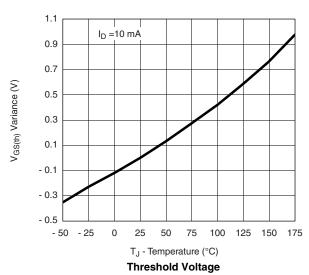




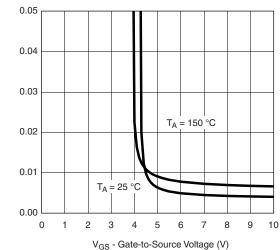
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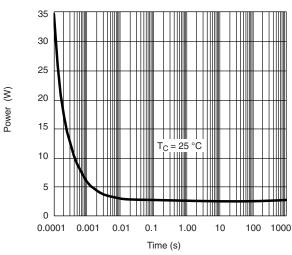
Source-Drain Diode Forward Voltage



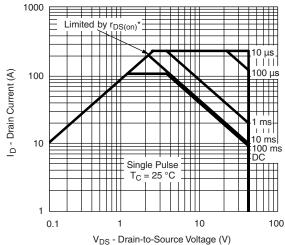
 $^{\text{rDS}(\text{on})}$ - Drain-to-Source On-Resistance (Ω)



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

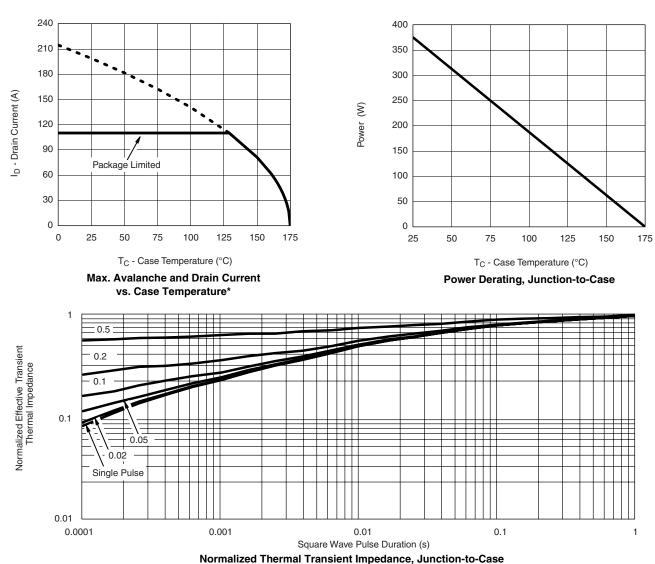


*V_{GS} > minimum V_{GS} at which r_{DS(on)} is specified

Safe Operating Area, Junction-to-Case



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

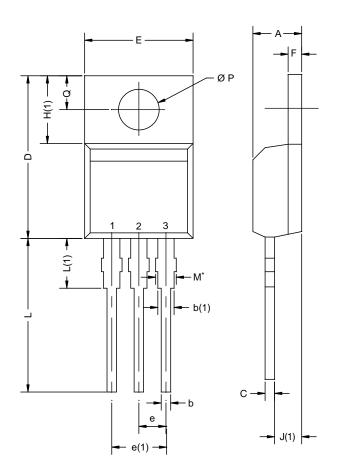


^{*} The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TO-220AB



	MILLIM	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471					

Notes

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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